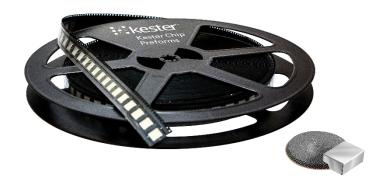


Kester Chip Preforms



KESTER CHIP PREFORMS ARE A PRECISION TECHNOLOGY USED FOR SELECTIVELY INCREASING SOLDER VOLUME ON PRINTED CIRCUIT BOARD ASSEMBLIES FEATURING:

- Available in numerous standard sizes
- Flux-free preform that relies on solder paste for reflow
- RoHS compliant alloys available
- Low temperature alloys available
- Easy automation using industry standard pick and place equipment
- IEC Tape and Reel Packaging

